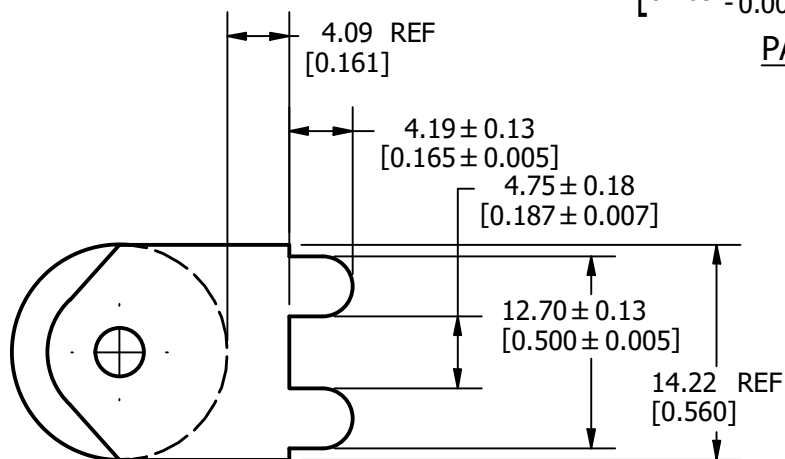
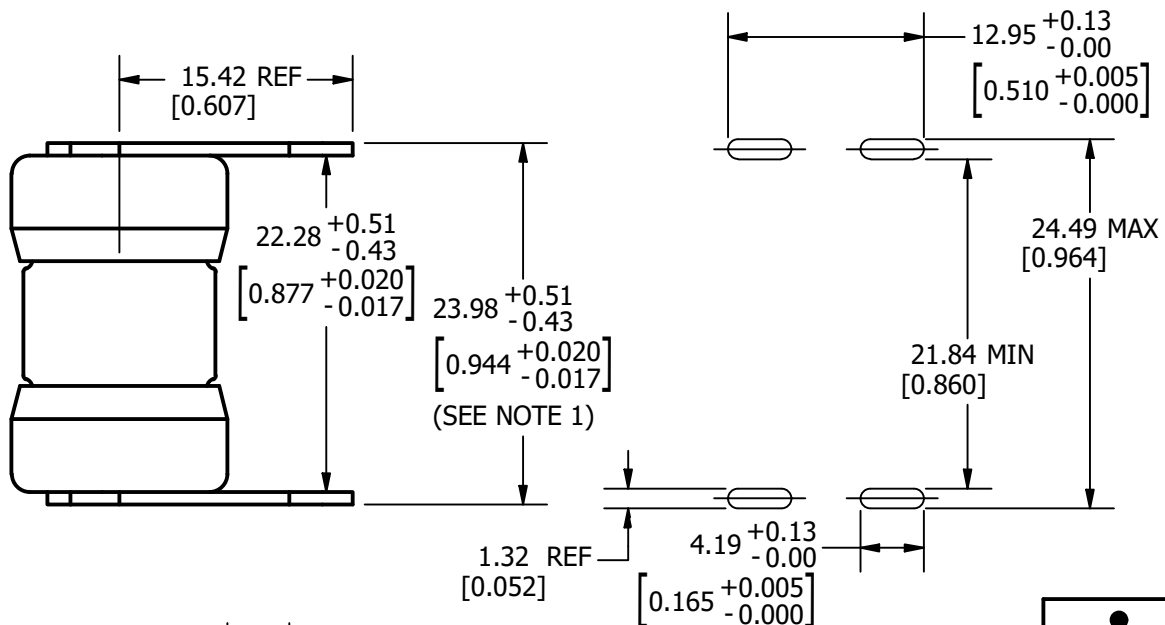


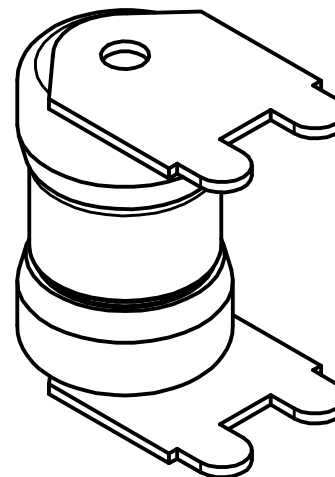


PAD LAYOUT

NOTE:
1. MEASUREMENT TAKEN AT END OF TERMINALS.

LEAD-FREE SOLDERING PROFILE:

PRE-HEAT: ABOVE 130°C FOR 75 SECONDS MAX.
REFLOW: 278°C FOR 8 SECONDS MAX.
TIME: 250 SECONDS MAX.
MAX. TEMP: 280°C



REV		DATE	REVISION	DESCRIPTION
A		2/15/18	518846GCP	- RELEASE PER EM3011 MRY

95

+0.13

-0.00

510

+0.005

-0.000

24.49 MAX

[0.964]

IN

●	DENOTES CRITICAL CHARACTERISTICS.		
CPK	DENOTES CPK DIMENSIONS, -MINIMUM CPK VALUE		
⬢ST⬢	DENOTES A CHARACTERISTIC THAT PROVIDES AN INDICATION OF PROCESS PERFORMANCE. PROCEDURE FOR MEASUREMENT AND TRACKING TO BE DEFINED IN LITTELFUSE INSPECTION INSTRUCTIONS.		
CP	DENOTES CP DIMENSIONS, -MINIMUM CP VALUE MUST BE WITHIN THE DIMENSIONAL LIMITATIONS SHOWN ON DRAWING AND INITIALLY LOCATED TO ALLOW FOR MAXIMUM TOOL LIFE.		
MATL SPEC		FINISH	
DRW MYORK	DATE 1/17/2018	SCALE NTS	FINISH GOOD WT GRAMS/PIECE
UNLESS OTHERWISE SPECIFIED, DIMENSIONS ARE IN MILLIMETERS, DIMENSIONS IN BRACKETS [] ARE INCHES DIMENSIONING AND DO NOT INCLUDE PLATING. TOLERANCING TO BE INTERPRETED IN ACCORDANCE WITH ANSI Y14.5M-1994			
3RD ANGLE PROJECTION			
TITLE JLLN-LSE OUTLINE			

 **Littelfuse®**
CHICAGO, ILLINOIS 60631

REVISION
A

DRWG NO.
OL-JLLN000LSE

SHEET 1 OF 1

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